

# MMBF4391LT1G, MMBF4392LT1G, MMBF4393LT1G

## JFET Switching Transistors

### N-Channel

#### Features

- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	30	Vdc
Drain-Gate Voltage	$V_{DG}$	30	Vdc
Gate-Source Voltage	$V_{GS}$	30	Vdc
Forward Gate Current	$I_{G(f)}$	50	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	225 1.8	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

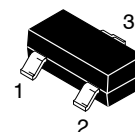
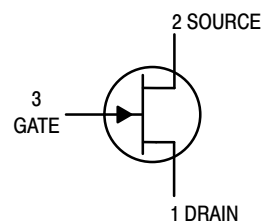
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 =  $1.0 \times 0.75 \times 0.062$  in.



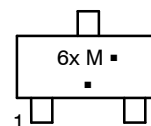
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SOT-23  
CASE 318  
STYLE 10

#### MARKING DIAGRAM



6x = Specific Device Code  
M = Date Code\*  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

#### DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 2 of this data sheet.

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

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## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
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### OFF CHARACTERISTICS

Gate–Source Breakdown Voltage (I <sub>G</sub> = 1.0 $\mu$ Adc, V <sub>DS</sub> = 0)	V <sub>(BR)GSS</sub>	30	–	Vdc
Gate Reverse Current (V <sub>GS</sub> = 15 Vdc, V <sub>DS</sub> = 0, T <sub>A</sub> = 25°C) (V <sub>GS</sub> = 15 Vdc, V <sub>DS</sub> = 0, T <sub>A</sub> = 100°C)	I <sub>GSS</sub>	– –	1.0 0.20	nAdc $\mu$ Adc
Gate–Source Cutoff Voltage (V <sub>DS</sub> = 15 Vdc, I <sub>D</sub> = 10 nAdc)	V <sub>GS(off)</sub>	–4.0 –2.0 –0.5	–10 –5.0 –3.0	Vdc
Off–State Drain Current (V <sub>DS</sub> = 15 Vdc, V <sub>GS</sub> = –12 Vdc) (V <sub>DS</sub> = 15 Vdc, V <sub>GS</sub> = –12 Vdc, T <sub>A</sub> = 100°C)	I <sub>D(off)</sub>	– –	1.0 1.0	nAdc $\mu$ Adc

### ON CHARACTERISTICS

Zero–Gate–Voltage Drain Current (V <sub>DS</sub> = 15 Vdc, V <sub>GS</sub> = 0)	MMBF4391LT1 MMBF4392LT1 MMBF4393LT1	I <sub>DSS</sub>	50 25 5.0	150 75 30	mAdc
Drain–Source On–Voltage (I <sub>D</sub> = 12 mAdc, V <sub>GS</sub> = 0) (I <sub>D</sub> = 6.0 mAdc, V <sub>GS</sub> = 0) (I <sub>D</sub> = 3.0 mAdc, V <sub>GS</sub> = 0)	MMBF4391LT1 MMBF4392LT1 MMBF4393LT1	V <sub>DS(on)</sub>	– – –	0.4 0.4 0.4	Vdc
Static Drain–Source On–Resistance (I <sub>D</sub> = 1.0 mAdc, V <sub>GS</sub> = 0)	MMBF4391LT1 MMBF4392LT1 MMBF4393LT1	r <sub>DS(on)</sub>	– – –	30 60 100	$\Omega$

### SMALL–SIGNAL CHARACTERISTICS

Input Capacitance (V <sub>DS</sub> = 0 Vdc, V <sub>GS</sub> = –15 Vdc, f = 1.0 MHz)	C <sub>iss</sub>	–	14	pF
Reverse Transfer Capacitance (V <sub>DS</sub> = 0 Vdc, V <sub>GS</sub> = –12 Vdc, f = 1.0 MHz)	C <sub>rss</sub>	–	3.5	pF

### ORDERING INFORMATION

Device	Marking	Package	Shipping <sup>†</sup>
MMBF4391LT1G	6J	SOT–23 (Pb–Free)	3000 / Tape & Reel
MMBF4392LT1G	6K	SOT–23 (Pb–Free)	
MMBF4393LT1G	6G	SOT–23 (Pb–Free)	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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## TYPICAL CHARACTERISTICS

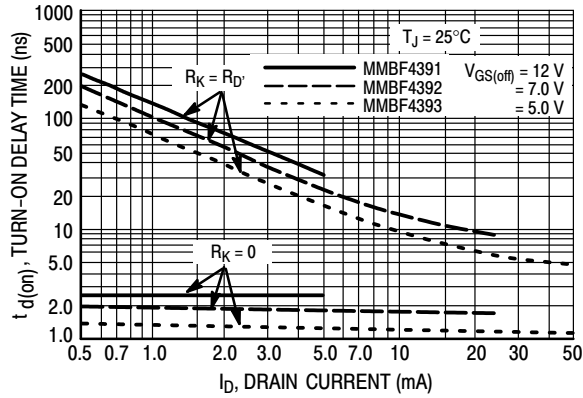


Figure 1. Turn-On Delay Time

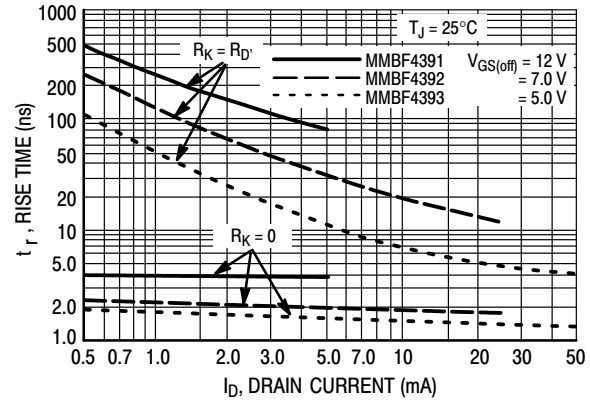


Figure 2. Rise Time

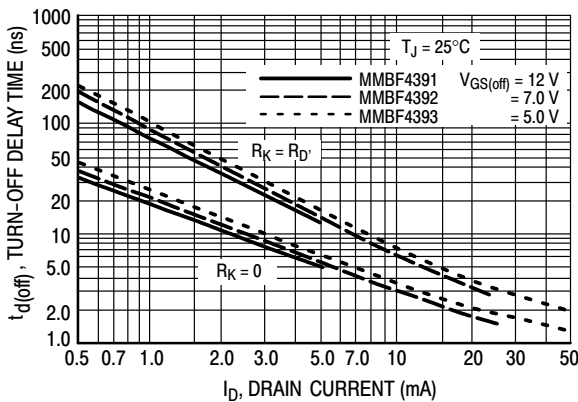


Figure 3. Turn-Off Delay Time

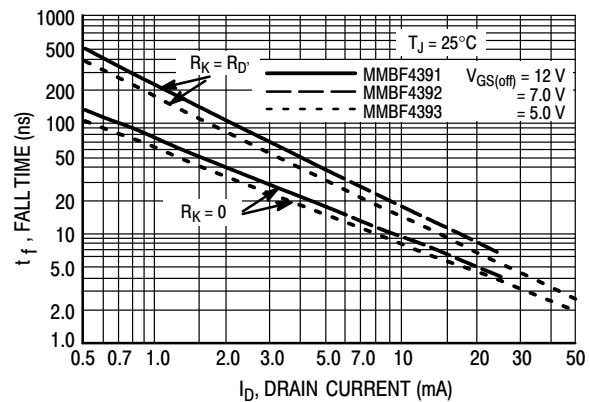


Figure 4. Fall Time

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NOTE 1

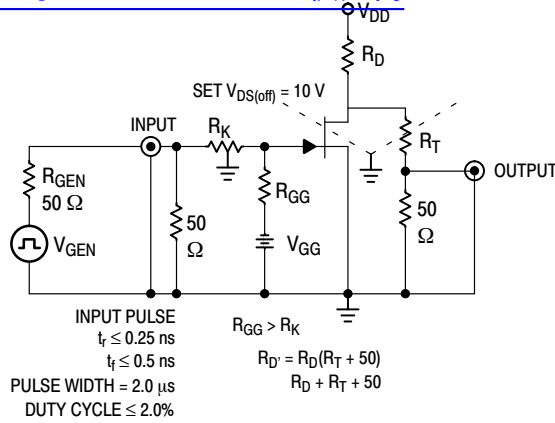


Figure 5. Switching Time Test Circuit

The switching characteristics shown above were measured using a test circuit similar to Figure 5. At the beginning of the switching interval, the gate voltage is at Gate Supply Voltage ( $-V_{GG}$ ). The Drain-Source Voltage ( $V_{DS}$ ) is slightly lower than Drain Supply Voltage ( $V_{DD}$ ) due to the voltage divider. Thus Reverse Transfer Capacitance ( $C_{rss}$ ) of Gate-Drain Capacitance ( $C_{gd}$ ) is charged to  $V_{GG} + V_{DS}$ .

During the turn-on interval, Gate-Source Capacitance ( $C_{gs}$ ) discharges through the series combination of  $R_{GEN}$  and  $R_K$ .  $C_{gd}$  must discharge to  $V_{DS(on)}$  through  $R_G$  and  $R_K$  in series with the parallel combination of effective load impedance ( $R'_D$ ) and Drain-Source Resistance ( $r_{DS}$ ). During the turn-off, this charge flow is reversed.

Predicting turn-on time is somewhat difficult as the channel resistance  $r_{DS}$  is a function of the gate-source voltage. While  $C_{gs}$  discharges,  $V_{GS}$  approaches zero and  $r_{DS}$  decreases. Since  $C_{gd}$  discharges through  $r_{DS}$ , turn-on time is non-linear. During turn-off, the situation is reversed with  $r_{DS}$  increasing as  $C_{gd}$  charges.

The above switching curves show two impedance conditions; 1)  $R_K$  is equal to  $R_D$ , which simulates the switching behavior of cascaded stages where the driving source impedance is normally the load impedance of the previous stage, and 2)  $R_K = 0$  (low impedance) the driving source impedance is that of the generator.

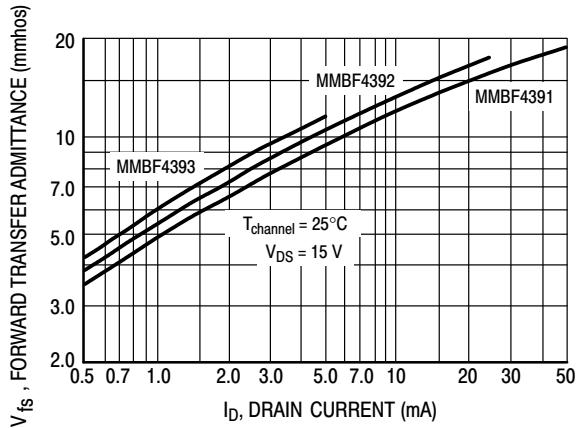


Figure 6. Typical Forward Transfer Admittance

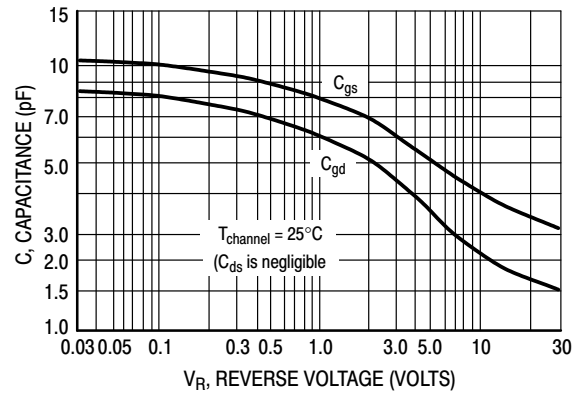


Figure 7. Typical Capacitance

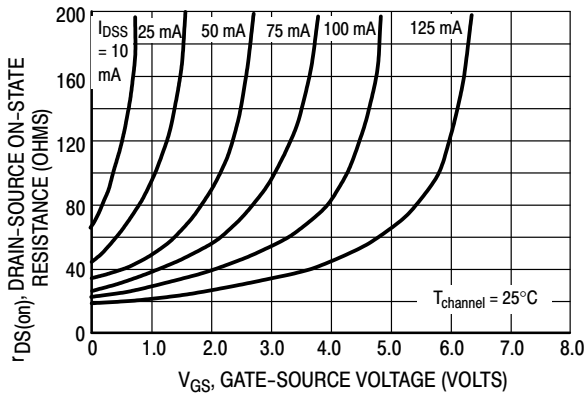


Figure 8. Effect of Gate-Source Voltage on Drain-Source Resistance

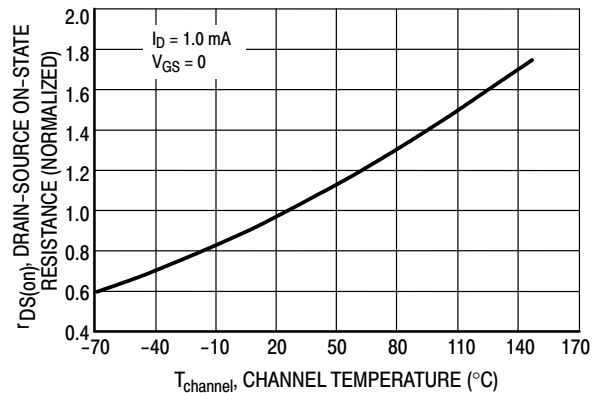
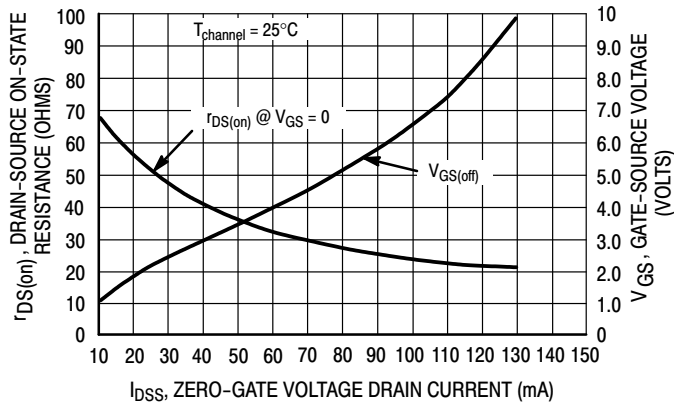


Figure 9. Effect of Temperature on Drain-Source On-State Resistance

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**Figure 10. Effect of  $I_{DSS}$  on Drain-Source Resistance and Gate-Source Voltage**

#### NOTE 2

The Zero-Gate-Voltage Drain Current ( $I_{DSS}$ ) is the principle determinant of other J-FET characteristics. Figure 10 shows the relationship of Gate-Source Off Voltage ( $V_{GS(off)}$ ) and Drain-Source On Resistance ( $r_{DS(on)}$ ) to  $I_{DSS}$ . Most of the devices will be within  $\pm 10\%$  of the values shown in Figure 10. This data will be useful in predicting the characteristic variations for a given part number.

For example:

Unknown

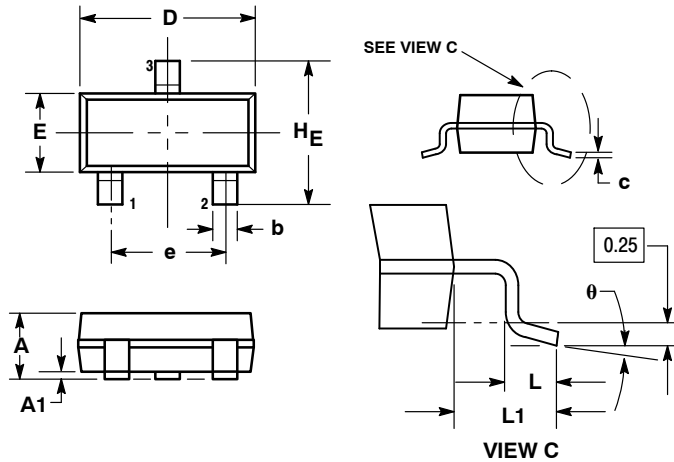
$r_{DS(on)}$  and  $V_{GS}$  range for an MMBF4392

The electrical characteristics table indicates that an MMBF4392 has an  $I_{DSS}$  range of 25 to 75 mA. Figure 10 shows  $r_{DS(on)} = 52 \Omega$  for  $I_{DSS} = 25$  mA and  $30 \Omega$  for  $I_{DSS} = 75$  mA. The corresponding  $V_{GS}$  values are 2.2 V and 4.8 V.

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## PACKAGE DIMENSIONS SOT-23 (TO-236) CASE 318-08 ISSUE AN



### NOTES:

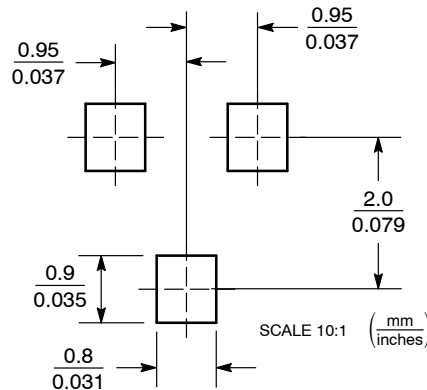
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
c	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
e	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104


### STYLE 10:

1. DRAIN
2. SOURCE
3. GATE

## SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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